TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

TC75S58AFE,TC75S58AFC

Single Comparator (Open-Drain Output)

The TC75S58AFE and TC75S58AFC are CMOS general-purpose single comparators. The devices can operate from a single supply voltage and are designed for a lower supply-current than conventional general-purpose bipolar comparators. The output is designed for Open-Drain Output and can supply a higher voltage than the power supply. Therefore, it is possible to pull-up the voltage to a level higher than that of the power supply. The Open-Drain Output can be wired-OR with another Open-Drain Output circuit.

* Output voltage should not exceed the maximum rating.

Feature

- Low Supply Current: $I_{DD} = 10 \ \mu A (typ.)$
- Single Power Supply Operation
- Wide Common Mode Input : V_{SS} to V_{DD} 0.9 V
- Open-Drain Output Circuit
- Low Input Bias Current
- Small Package



SON5-P-0.50 : 0.003 g (typ.) CSON6-P-0.45 : 0.002 g (typ.)

Marking (top view)

TC75S58AFE



TC75S58AFC



Pin Assignment (top view)

TC75S58AFE



TC75S58AFC



Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol Rating		ing	Unit	
Supply Voltage	V _{DD} , V _{SS}	±3.5 or 7		V	
Differential Input Voltage	DVIN	±7		V	
Input Voltage	V _{IN}	V_{SS} to V_{DD}		V	
Output Current	Ι _Ο	±35		mA	
Output Voltage	VO	V_{SS} to V_{SS} + 7		V	
Power Dissipation	Po	TC75S58AFE	100	mW	
	гD	TC75S58AFC	100 (Note1)		
Operating Temperature	T _{opr}	-40 to 85		°C	
Storage Temperature	T _{stg}	-55 to 125		°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: Due to the CMOS structure, this device may be susceptible to latch-up. To prevent latch-up, please take the following precautions;

• Ensure that no Input pin voltage level ever exceeds Vdd or drops below Vss. In addition, check the power-on timing.

• Do not subject the device to excessive noise.

(Note 1): FR4 in board implementation:

(25.4mm × 25.4mm × 1.6t, Cu Pad: 0.4mm²)

Electrical Characteristics ($V_{DD} = 5 V$, $V_{SS} = GND$, $Ta = 25^{\circ}C$)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input Offset Voltage	V _{IO}	_	—	_	±1	±7	mV
Input Offset Current	I _{IO}		—	_	1		pА
Input Bias Current	lj	—	—	_	1	_	pА
Common Mode Input Voltage	CMVIN	—	—	0	_	4.1	V
Supply Current	I _{DD} (Note)	—	—	_	11	22	μA
Voltage Gain	GV	—	—	_	94	_	dB
Sink Current	I _{sink}	—	V _{OL} = 0.5 V	13	25	_	mA
Output Leakage Current	I _{LEAK}	—	$V_{DD} = 5 V$, $V_O = 5 V$	_	5	—	nA
Off-State Leakage Current	I _{OFF}	—	$V_{DD} = 0 V$, $V_O = 5 V$	_	5	_	nA
Output-Low Voltage	V _{OL}	—	I _{sink} = 5.0 mA	_	0.1	0.3	V
Operating Supply Voltage Range	V _{DD}	—	—	1.8	_	7.0	V
Propagation Delay (Turn On)	^t PLH (1)	—	Over Drive = 100 mV	_	800	—	200
	t _{PLH (2)}	—	TTL Step Input	_	620	—	115
Propagation Delay (Turn Off)	t _{PHL (1)}	—	Over Drive = 100 mV	_	230	—	200
	t _{PHL (2)}	—	TTL Step Input	_	350	—	115
Response Time	t _{TLH}		Over Drive = 100 mV	_	190		200
	t _{THL}		Over Drive = 100 mV	_	6	_	115

Electrical Characteristics ($V_{DD} = 3 V$, $V_{SS} = GND$, $Ta = 25^{\circ}C$)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input Offset Voltage	V _{IO}		—	_	±1	±7	mV
Input Offset Current	I _{IO}		—	_	1	_	pА
Input Bias Current	lj		_	_	1	_	pА
Common Mode Input Voltage	CMVIN		—	0	_	2.1	V
Supply Current	I _{DD} (Note)		—	_	10	20	μA
Sink Current	I _{sink}		V _{OL} = 0.5 V	6	18	_	mA
Output Leakage Current	I _{LEAK}		$V_{DD} = 3 V$, $V_O = 3 V$	_	5	_	nA
Off-State Leakage Current	I _{OFF}		$V_{DD} = 0 V$, $V_O = 3 V$	_	5	_	nA
Output-Low Voltage	V _{OL}		I _{sink} = 5.0 mA	_	0.15	0.35	V
Propagation Delay (Turn On)	t _{PLH}		Over Drive = 100 mV	_	590	_	ns
Propagation Delay (Turn Off)	t _{PHL}		Over Drive = 100 mV	_	230	_	ns
Response Time	t _{TLH}		Over Drive = 100 mV		170		20
	t _{THL}		Over Drive = 100 mV		5		115

Note: The current consumption of this device increases as its operating frequency increases. Note that the power dissipation should not exceed the allowable power.

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Package Dimension

SON5-P-0.50

Unit : mm



Weight: 0.003 g (typ.)

Package Dimension

CSON6-P-0.45

Unit: mm



Weight: 0.002 g (typ.)

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